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BTW42 SERIES

THYRISTORS

Glass-passivated silicon thyristors in metal envelopes with high dV_D/dt capabilities. They are intended for use in power control circuits and switching systems where high transients can occur (e.g. phase control in three-phase systems).

The series consists of reverse polarity types (anode to stud) identified by a suffix R: BTW42-600R to 1000R.

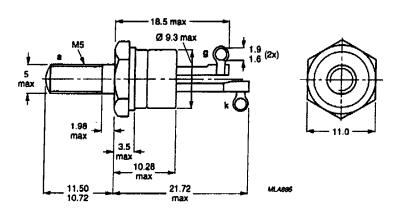
QUICK REFERENCE DATA

Repetitive peak voltages	^V DRM ^{/V} RRM	BTW42-600 R		800 R	1000 R	
		max.	600	800	1000	v
Average on-state current	T(AV)	max.		10		Α
R.M.S. on-state current	T(RMS)	max.		16		Α
Non-repetitive peak on-state current	ITSM	max.		150		А
Rate of rise of off-state voltage that will not trigger any device	dV _D /dt	<		500		V/μs
On request (see Ordering Note)	dV _D /dt	<		1000		V/μs

MECHANICAL DATA

Dimensions in mm

Fig.1 TO-64





RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Anode to cathode					4000	~
Non-repetitive peak voltages		BTW42		800R	1000	-
(t ≤ 10 ms)	V _{DSM} /V _{RSM}	max.	600	800	1000	-
Repetitive peak voltages	VDRM/VRRM	max.	600	800	1000	V
Crest working voltages	V _{DWM} /V _{RWM}	max.	40 0	600	700	۷*
Average on-state current (averaged over any 20 ms period) up to T _{mb} = 85 ^o C		IT(A)	/)	max.	10	A
R.M.S. on-state current		IT(RM	NS)	max.	16	Α
Repetitive peak on-state current		ITRM	-	max,	75	Α
Non-repetitive peak on-state current; t = 10 m half sine-wave; T _j = 125 ^o C prior to surge;	ns;					_
with reapplied VRWMmax		ITSM		max.	150	
l^2t for fusing (t = 10 ms)		l²t		max.	112	A²s
Rate of rise of on-state current after triggering with $I_G = 250$ mA to $I_T = 25$ A; $dI_G/dt = 0$	•	dl T /d	t	max.	5 0	A/µs
Gate to cathode						
Average power dissipation (averaged over any 20 ms period)		PG(A)	V)	max.	0,5	w
Peak power dissipation		PGM		max.	5	w
Temperatures						
Storage temperature		T _{stg}		—55 to -	+ 125	oC
Junction temperature		тј		max.	125	οC
THERMAL RESISTANCE						
From junction to mounting base		R _{th j-r}	nb	-	1,8	K/W
From mounting base to heatsink with heatsink compound		R _{th m}	h-h	=	0,5	K/W
From junction to ambient in free air		R _{th j-a}		-	-	K/W
Transient thermal impedance $(t = 1 ms)$		Z _{th j-n}		-	0,1	

OPERATING NOTE

The terminals should neither be bent nor twisted; they should be soldered into the circuit so that there is no strain on them.

During soldering the heat conduction to the junction should be kept to a minimum.

CHARACTERISTICS

Anode to cathode

On-state voltage (measured under pulse conditions) I _T = 20 A; T _j = 25 °C	۷ _T	<	2	v
Rate of rise of off-state voltage that will not trigger any device; expontential method; V _D = 2/3 V _{DRMmax} ; T _j = 125 ^o C	dV _D /dt	<	500	V/µs
Reverse current			-	
V _R = V _{RWMmax} ; T _j = 125 °C	^I R	<	3	mA
Off-state current			_	_
V _D = V _{DWMmax} ; T _j = 125 ^o C	D	<	3	mA
Latching current; T _j = 25 °C	۱L	<	150	mA
Holding current; $T_j = 25 \text{ °C}$	н	<	75	mA
Gate to cathode				
Voltage that will trigger all devices $V_D = 6 V; T_i = 25 {}^{O}C$	V _{GT}	>	1.5	v
Voltage that will not trigger any device				
$V_D = V_{DRMmax}$; $T_i = 125 \ ^{\circ}C$	V _{GD}	<	200	mV
Current that will trigger all devices				
$V_{\rm D} = 6 \ V; \ T_{\rm j} = 25 \ ^{\circ}{\rm C}.$	IGT	>	50	mA
Switching characteristics				
Gate-controlled turn-on time (t _{gt} = t _d + t _r) when switched from V _D ≠ V _{DRMmax} to I _T = 40 A; I _{GT} = 100 mA; dI _G /dt = 5 A/µs; T _i = 25 °C	ta	typ.	2	μs
<u> </u>	^t gt	.16.	-	و مو
Circuit commutated turn off time when switched from $l_T = 40 \text{ A to V}_R > 50 \text{ V with}$				
dl _T /dt = 10A/μs; dV _D /dt = 50 V/μs; T _j = 115 ^o C	tq	typ.	35	μs